# 501773362 01/01/2012

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Chin-Sheng Yang	10/20/2008

### **RECEIVING PARTY DATA**

Name:	UNITED MICROELECTRONICS CORP.	
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	
City:	Hsin-Chu City	
State/Country:	TAIWAN	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13342106

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ATTORNEY DOCKET NUMBER:	NAUP1037USA1
NAME OF SUBMITTER:	SHELLEY KUO

Total Attachments: 2 source=1274769#page1.tif source=1274769#page2.tif

> PATENT REEL: 027467 FRAME: 0342

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# ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR	(S) (Inventors):			
Name:	Chin-Sheng Yang	Nationality: _I	R.O.C.	
•				
Hereby sells, a	ssigns and transfers to			
ASSIGNEE(S	):			
Name:	UNITED MICROELECTRON	ICS CORP.		
Address:	: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.			
any and all im	ssors and assignees of the ASSIG provements which are disclosed in CAPACITOR AND METHOD OF	n the invention entitled:	l interest in and to	
Which is four	nd in :			
(a) <u>+</u>	U.S. patent application executed	on even date		
(b)	U.S. patent application executed	on	_	
(c)	U.S. application serial no		_	
(d)	patent no is	sued	<b></b>	

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F#NPO-P0002E-US1 DSB0-097U021792

**PATENT** 

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this OCT 2 0 2008(Date of signing). (清豫明人務必簽署上列日期 1)

(Type name of inventor)

Signature of INVENTOR

Chin-Sheng Yang

Chinsheng Yang

Assignment, Page 2 of 2

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